



IFW 2815 \$

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Ko et al.

Serial No.: 09/585,682

Filed: June 1, 2000

For: SEMICONDUCTOR DEVICE  
HAVING A SUBSTRATE, AN UNDOPE  
SILICON OXIDE STRUCTURE, AND AN  
OVERLYING DOPED SILICON OXIDE  
STRUCTURE WITH A SIDEWALL  
TERMINATING AT THE UNDOPE  
SILICON OXIDE STRUCTURE (Amended)

Confirmation No.: 7481

Examiner: C. Chu

Group Art Unit: 2815

Attorney Docket No.: 2269-3526.2US  
(97-1136.02/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

October 12, 2006  
Date

Signature

Erika Gandre  
Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 or PTO/SB/08 be considered by the Examiner and made of record. Copies of any cited foreign patents,

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publications, or pending unpublished U.S. applications are enclosed pursuant to 37 C.F.R. § 1.98(a)(2).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

Foreign Patent Documents

<u>Document No.</u>	<u>Publication Date</u>	<u>Patentee</u>
JP 07-161702	06/23/1995	Applied Materials
JP 09-027483	01/28/1997	Cypress Semicon.
JP 11-204507	07/30/1999	Sharp Corp.
JP 2000-156366	06/06/2000	Sony Corp

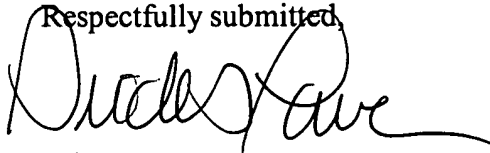
Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the Notice of Allowance, but before payment of the issue fee.

I hereby certify that no item of information contained in the Supplemental Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement. Pursuant to 37 C.F.R. § 1.97(d)(ii), applicant hereby requests consideration of the accompanying Supplemental Information Disclosure Statement. The fee pursuant to 37 C.F.R. §1.17(p) for consideration of this Supplemental Information Disclosure Statement is enclosed.

Serial No. 09/585,682

Respectfully submitted,

A handwritten signature in black ink, appearing to read "Brick G. Power", written over the typed name.

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Date: October 12, 2006  
BGP/nj:eg

Enclosures: Form PTO-1449 or PTO/SB/08  
Cited Non-U.S. Patent Documents  
Check No. 10265 in the amount of \$180

Document in ProLaw

